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July 1997 Revised April 2005

74VHCT574A Octal D-Type Flip-Flop with 3-STATE Outputs

General Description

The VHCT574A is an advanced high speed CMOS octal flip-flop with 3-STATE output fabricated with silicon gate CMOS technology. It achieves the high speed operation similar to equivalent Bipolar Schottky TTL while maintaining the CMOS low power dissipation. This 8-bit D-type flip-flop is controlled by a clock input (CP) and an Output Enable input ($\overline{\text{OE}}$). When the $\overline{\text{OE}}$ input is HIGH, the eight outputs are in a high impedance state.

Protection circuits ensure that 0V to 7V can be applied to the input and output (Note 1) pins without regard to the supply voltage. This device can be used to interface 3V to 5V systems and two supply systems such as battery back up. This circuit prevents device destruction due to mismatched supply and input voltages.

Note 1: Outputs in OFF-State.

Features

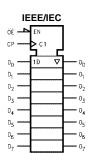
- High speed: $f_{MAX} = 140 \text{ MHz}$ (typ) at $T_A = 25^{\circ}\text{C}$
- Power Down Protection is provided on all inputs and outputs.
- Low Noise: V_{OLP} = 1.6V (max)
- Low Power Dissipation: $I_{CC} = 4~\mu A~(max)~@~T_A = 25 ^{\circ}C$
- Pin and Function Compatible with 74HCT574

Ordering Code:

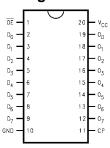
Order Number	Package Number	Package Description
74VHCT574AM	M20B	20-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-013, 0.300" Wide
74VHCT574ASJ	M20D	Pb-Free 20-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide
74VHCT574AMTC	MTC20	20-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide
74VHCT574AN	N20A	20-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300" Wide

Surface mount packages are also available on Tape and Reel. Specify by appending the suffix letter "X" to the ordering code. Pb-Free package per JEDEC J-STD-020B.

Logic Symbol



Connection Diagram



Pin Descriptions

Pin Names	Description
D ₀ -D ₇	Data Inputs
СР	Clock Pulse Input 3-STATE
ŌĒ	Output Enable Input 3-STATE
O ₀ -O ₇	Outputs

Truth Table

	Outputs		
D _n	СР	ŌE	O _n
Н		L	Н
L	~	L	L
Х	Х	Н	Z

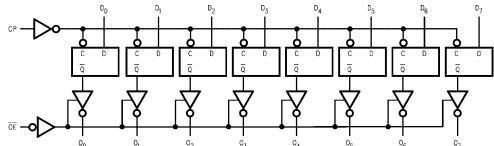
- H = HIGH Voltage Level L = LOW Voltage Level
- X = Immaterial

Functional Description

The VHCT574A consists of eight edge-triggered flip-flops with individual D-type inputs and 3-STATE true outputs. The buffered clock and buffered Output Enable are common to all flip-flops. The eight flip-flops will store the state of their individual D inputs that meet the setup and hold time requirements on the LOW-to-HIGH Clock (CP) transi-

tion. With the Output Enable ($\overline{\text{OE}}$) LOW, the contents $\underline{\text{of the}}$ eight flip-flops are available at the outputs. When the OE is HIGH, the outputs go to the high impedance state. Operation of the OE input does not affect the state of the flipflops.

Logic Diagram



Please note that this diagram is provided only for the understanding of logic operations and should not be used to estimate propagation delays.

Absolute Maximum Ratings(Note 2)

-0.5V to +7.0V Supply Voltage (V_{CC}) DC Input Voltage (V_{IN}) -0.5V to +7.0V

DC Output Voltage (V_{OUT})

(Note 3) -0.5V to $V_{CC} + 0.5V$ (Note 4) -0.5V to +7.0V

Input Diode Current (I_{IK}) -20 mA Output Diode Current (I_{OK}) (Note 5) ±20 mA DC Output Current (I_{OUT}) ±25 mA

DC V_{CC}/GND Current (I_{CC}) $\pm 75~\text{mA}$ Storage Temperature (T_{STG}) -65°C to +150°C

Lead Temperature (T_L)

(Soldering, 10 seconds) 260°C

Recommended Operating Conditions (Note 6)

4.5V to +5.5V Supply Voltage (V_{CC}) 0V to +5.5V

Input Voltage (V_{IN})

Output Voltage (V_{OUT})

(Note 3) 0V to $V_{\mbox{\footnotesize CC}}$ 0V to +5.5V (Note 4) Operating Temperature (T_{OPR}) -40°C to +85°C

Input Rise and Fall Time $(t_r, \, t_f)$

 $V_{CC} = 5.0V \pm 0.5V$ 0 ns/V \sim 20 ns/V

Note 2: Absolute Maximum Ratings are values beyond which the device may be damaged or have its useful life impaired. The databook specifications should be met, without exception, to ensure that the system design is reliable over its power supply, temperature, and output/input loading variables. Fairchild does not recommend operation outside databook specifica-

Note 3: HIGH or LOW state. $\mathbf{I}_{\mathrm{OUT}}$ absolute maximum rating must be observed.

Note 4: When outputs are in OFF-State or when $\rm V_{CC} = \rm OV.$

Note 5: $V_{OUT} < GND$, $V_{OUT} > V_{CC}$ (Outputs Active). Note 6: Unused inputs must be held HIGH or LOW. They may not float.

DC Electrical Characteristics

Symbol	Parameter	V _{CC}	T _A = 25°C			$T_A = -40^{\circ}C \text{ to } +85^{\circ}C$		Units	Conditions	
Symbol		(V)	Min	Тур	Max	Min	Max	Ullits	Conditions	
V _{IH}	HIGH Level	4.5	2.0			2.0		V		
	Input Voltage	5.5	2.0			20		v		
V _{IL}	LOW Level	4.5			0.8		0.8	V		
	Input Voltage	5.5			0.8		0.8	V		
V _{OH}	HIGH Level	4.5	4.40	4.50		4.40		V	$V_{IN} = V_{IH}$ $I_{OH} = -50 \mu A$	
	Output Voltage	4.5	3.94			3.80		V	or V_{IL} $I_{OH} = -8 \text{ mA}$	
V _{OL}	LOW Level	4.5		0.0	0.1		0.1	V	$V_{IN} = V_{IH}$ $I_{OL} = 50 \mu A$	
	Output Voltage	4.5			0.36		0.44	V	or V _{IL} I _{OL} = 8 mA	
l _{oz}	3-STATE Output	5.5			±0.25		±2.5	μА	$V_{IN} = V_{IH}$ or V_{IL}	
	Off-State Current	5.5			±0.23	±2.5	μА	V _{OUT} = V _{CC} or GND		
I _{IN}	Input Leakage	0-5.5			±0.1		±1.0	μΑ	V _{IN} = 5.5V or GND	
	Current									
I _{CC}	Quiescent Supply	5.5			4.0		40.0	μΑ	V _{IN} = V _{CC} or GND	
	Current									
I _{CCT}	Maximum I _{CC} /Input	5.5			1.35		1.50	mA	V _{IN} = 3.4V	
									Other Input = V _{CC} or GND	
I _{OFF}	Output Leakage Current	0.0			0.5		5.0	μА	V _{OUT} = 5.5V	
	(Power Down State)									

Noise Characteristics

Symbol	Parameter	V _{CC} (V)	T _A =	25°C	Units	Conditions	
	T didilictor		Тур	Limits	O.I.I.S	Conditions	
V _{OLP} (Note 7)	Quiet Output Maximum Dynamic V _{OL}	5.0	1.2	1.6	V	C _L = 50 pF	
V _{OLV} (Note 7)	Quiet Output Minimum Dynamic V _{OL}	5.0	-1.2	-1.6	V	C _L = 50 pF	
V _{IHD} (Note 7)	Minimum HIGH Level Dynamic Input Voltage	5.0		2.0	V	C _L = 50 pF	
V _{ILD} (Note 7)	Maximum LOW Level Dynamic Input Voltage	5.0		0.8	V	C _L = 50 pF	

Note 7: Parameter guaranteed by design.

AC Electrical Characteristics

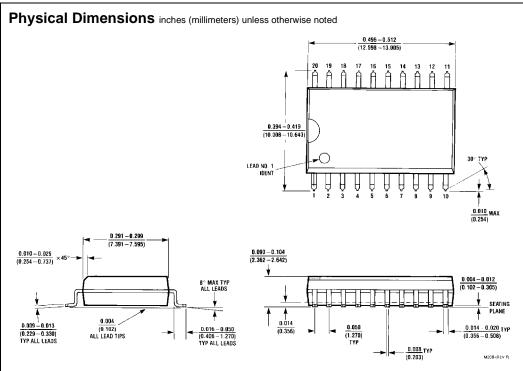
Symbol	Parameter	v _{cc}	$T_A = 25^{\circ}C$		T _A = -40°	C to +85°C	Units	Conditions		
- Cymbol	- urumeter	(V)	Min	Тур	Max	Min	Max	Units	Conditions	
t _{PLH}	Propagation Delay	5.0 ± 0.5		4.1	9.4	1.0	10.5	ns		C _L = 15 pF
t _{PHL}	Time	3.0 ± 0.3		5.6	10.4	1.0	11.5	115		$C_L = 50 pF$
t _{PZL}	3-STATE Output	5.0 ± 0.5		6.5	10.2	1.0	11.5	ns	$R_L = 1 k\Omega$	$C_L = 15 pF$
t _{PZH}	Enable Time	3.0 ± 0.3		7.3	11.2	1.0	12.5	115		$C_L = 50 pF$
t _{PLZ}	3-STATE Output	5.0 ± 0.5		7.0	11.2	1.0	12.0	ns	$R_L = 1 k\Omega$	$C_L = 50 pF$
t _{PHZ}	Disable Time	3.0 ± 0.3		7.0	11.2	1.0	12.0	115		
toslh	Output to	5.0 ± 0.5			1.0		1.0		(Note 8)	
toshl	Output Skew	5.0 ± 0.5			1.0		1.0	ns		
f _{MAX}	Maximum Clock	5.0 ± 0.5	90	140		80		MHz		C _L = 15 pF
	Frequency	3.0 ± 0.3	85	130		75		IVITIZ		$C_L = 50 pF$
C _{IN}	Input			4	10		10	pF	V _{CC} = Oper	1
	Capacitance									
C _{OUT}	Output			9				pF	$V_{CC} = 5.0V$	
	Capacitance									
C _{PD}	Power Dissipation			25				pF	(Note 9)	
	Capacitance									

Note 8: Parameter guaranteed by design. $t_{OSLH} = |t_{PLH \; max} - t_{PLH \; min}|; t_{OSHL} = |t_{PHL \; max} - t_{PHL \; min}|$

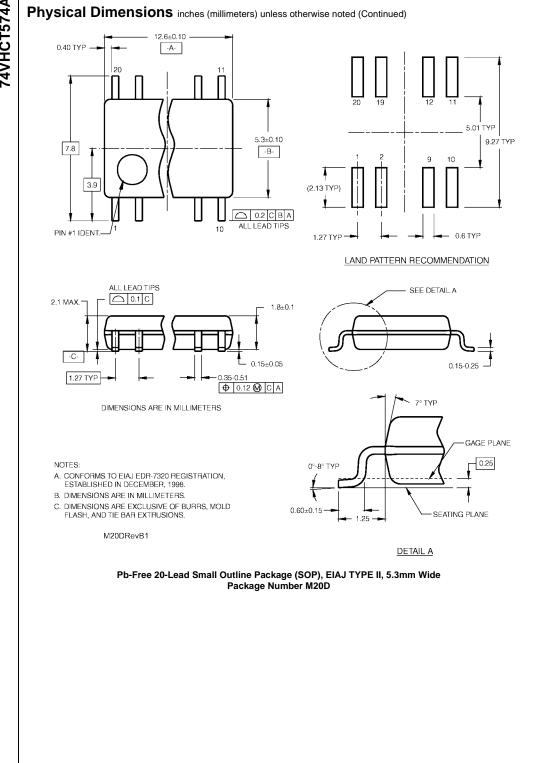
Note 9: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained by the equation: I_{CC} (opr.) = C_{PD} * V_{CC} * f_{IN} + I_{CC} /8 (per F/F). The total C_{PD} when n pcs. of the Octal D Flip-Flop operates can be calculated by the equation: C_{PD} (total) = 20 + 12n.

AC Operating Requirements

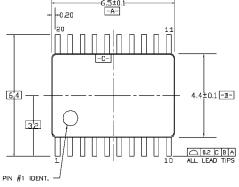
Symbol	Parameter	V _{CC}		$T_A = 25^{\circ}C$		T _A = -40°	Units	
		(V)	Min	Тур	Max	Min	Max	Oilits
t _W (H)	Minimum Pulse Width (CP)	5.0 ± 0.5	6.5			8.5		ns
$t_W(L)$		5.0 ± 0.5	6.5			0.5		115
t _S	Minimum Set-Up Time	5.0 ± 0.5	2.5			2.5		ns
t _H	Minimum Hold Time	5.0 ± 0.5	2.5			2.5		115

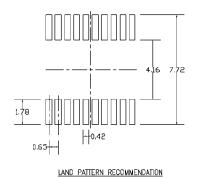


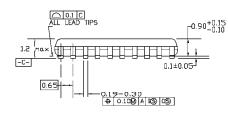
20-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-013, 0.300" Wide Package Number M20B



Physical Dimensions inches (millimeters) unless otherwise noted (Continued)









DIMENSIONS ARE IN MILLIMETERS

NOTES:

- A. CONFORMS TO JEDEC REGISTRATION MD-153, VARIATION AC, REF NOTE 6, DATE 7/93.
- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLDS FLASH, AND TIE BAR EXTRUSIONS.
- D. DIMENSIONS AND TOLERANCES PER ANSI Y14.5M, 1982.

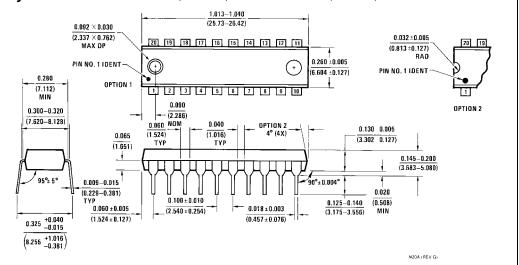
|-12.00° R0.09mir GAGE PLANE 0.6±0.1 R0.09min -1.00

DETAIL A

MTC20REVD1

20-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide Package Number MTC20

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



20-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300" Wide Package Number N20A

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